Declaration and Power of Attorney United States Patent Application

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

SOLID STRUCTURE

☐ is attached hereto.

addressed to the address filed under the same USTPO Customer Number.

(check one)

was filed as U.S. Application No		on	_ and (if
⊠was filed as Po		PCT/JP2004/005093 on Apr on	ril 8, 2004 and (if
I have reviewed and understand the camendment referred to above. I acknowledge the duty to disclose in Regulations, §1.56.	·	cation, including the claims, as amen	
application(s) for patent or inventor's country other than the United States of for patent or inventor's certificate or I priority is claimed:	certificate, or §365(a) of any PCT int of America listed in this Declaration.	§119(a)-(d) or §365(b) of any foreign ernational application which designat I have also identified below any foreign in filing date before that of the application	ed at least one gn application
Foreign/PCT Application No.	Country	Filing Date	Priority Claimed? (yes/no)
2003-107179	Japan	4/11/2003	Yes
I hereby claim the benefit under Title international application designating teach of the claims of this application manner provided by the first paragrap	the United States of America listed in is not disclosed in the prior United St	this Declaration and, insofar as the states application or PCT international	abject matter of application in the
which is material to patentability as d	efined in Title 37, Code of Federal Re	gulations, §1.56 which became available	able between the
filing date of the prior application and			
U.S. Application No.	Filing Date	Status (patented/pending/abandoned?)	
	35 United States Code §119(e) of any U.S	S. provisional application(s) listed below:	
U.S. Provisional Application No.	Filing Date	<u>.</u>	
I/we hereby armoint all attac	man of Smith Combrell & Duscell I	ID who are listed under the HEDTO	Customer

00441

Number shown below as my/our attorneys to prosecute this application and to transact all business in the United States Patent and Trademark Office connected therewith, recognizing that the specific attorneys listed under that Customer Number may be changed from time to time at the sole discretion of Smith, Gambrell & Russell, LLP, and request that all correspondence be

Please send all correspondence to: SMITH, GAMBRELL & RUSSELL, LLP, 1850 M Street, N.W. (Suite 800), Washington, D.C. 20036. All facsimiles may be sent to (202) 263-4329. Direct all phone calls to (202) 263-4300.

Address all correspondence to:

Michael A. Makuch SMITH, GAMBRELL & RUSSELL, L.L.P. 1850 M Street, N.W., Suite 800 Washington, DC 20036-5819

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor: Mitsuo SASAKI Residence (city, state, country): Tokyo, Japan Post office address: 10-15, Omori-Kita 5-chome,	Citizenship: Japan Ota-ku, Tokyo 143-0016 Japan	
Signature: 152 = 3	Date: Sep. 1, 2005	`
Full name of second inventor: Residence (city, state, country): Post office address:	Citizenship:	
Signature:	Date:	